
Programmable USB Power Delivery Controller

Highlights

- Integrated USB Power Delivery (PD) PHY
- Support for Power Delivery Message Protocol
- Integrated Voltage and Current ADC Inputs
- Configuration Profile Selection
- On-chip Microcontroller
- SPI Interface
- Commercial, Industrial, and Automotive Grade Temperature Support
- Available in 28-TSSOP and 32-SQFN Packages

Target Applications

- AC Adapters & Chargers
 - Type-A
 - Type-B
 - Micro-A
 - Micro-B
 - Captive cable

Key Benefits

- Integrated USB Power Delivery (PD) PHY
 - Integrated receive termination
 - Requires minimal external components
- Support for Power Delivery Message Protocol
 - Message Generation/Consumption
 - Retry Generation
 - Error Handling
 - State Behavior
- Cable Detect Logic
 - Cable attachment type
- CFG_SEL pins allow selection of multiple profiles
 - Provider
 - Consumer/Provider
- Integrated Voltage (VMON) and Current (IMON) ADC Inputs
- Dead Battery Support
- On-chip Microcontroller
 - Manages I/Os and other signals
 - Implements power delivery policy engine and device policy manager
- Configuration Programming via OTP, or Vendor Defined Messaging
- Supports Low Power Modes
- Serial Peripheral Interface (SPI) Bus
- Internal 3.3 V and 1.8 V Voltage Regulators
- Integrated Oscillator Reduces BOM Costs
- Package
 - 28-pin TSSOP (9.7 x 6.1 mm)
 - 32-pin SQFN (5 x 5 mm)
- Environmental
 - Commercial temperature range (0°C to +70°C)
 - Industrial temperature range (-40°C to +85°C)
 - Automotive temperature range (-40°C to +105°C)

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1.0 INTRODUCTION

1.1 General Description

The UPD1001 is a programmable USB Power Delivery (PD) controller designed to adhere to the *USB Power Delivery Specification*. USB Power Delivery allows a host (or device) to provide or consume up to 5 Amps and/or up to 20 Volts of power from a USB PD capable partner device on the other end of the USB cable. USB PD capable standard and custom cables/connectors are supported, which in most cases are backward compatible with standard USB connections.

The UPD1001 provides a complete USB Power Delivery solution for all charger and adapter solutions. The functionality of the UPD1001 is selected via two configuration selection pins, **CFG_SEL0** and **CFG_SEL1**, which can be used to select unique PD and system configurations. Designing the UPD1001 into a system can be as simple as selecting a configuration, with no external EEPROM required. Advanced programmability options exist with an external EEPROM installed.

The integrated USB Power Delivery MAC and PHY support provider and consumer operation via the PD communication protocol, as specified in Revision 1.0 (Version 1.2) of the *USB Power Delivery Specification*. Monitoring of VBUS and battery charging is accomplished via the integrated voltage and current ADC inputs. The PHY supports cable ID detection/identification and loopback modes. The PHY includes a 24MHz FSK modulator/demodulator and provides integrated terminations. The USB PD MAC supports both USB PD insertion detection (cold socket) and dead battery cases.

The on-chip microcontroller manages the IOs and implements the power delivery local policy engine and device manager. The SPI ROM controller is used by the microcontroller for optional external code execution from ROM. A One Time Programmable (OTP) ROM is integrated in the UPD1001. Integrated 3.3 V and 1.8 V regulators allow device operation from a single power supply. The UPD1001 is available in commercial (0°C to +70°C), industrial (-40°C to +85°C), and automotive (-40°C to +105°C) temperature ranges. An internal block diagram of the UPD1001 is shown in [Figure 1-1](#).

UPD1001

FIGURE 1-1: INTERNAL BLOCK DIAGRAM

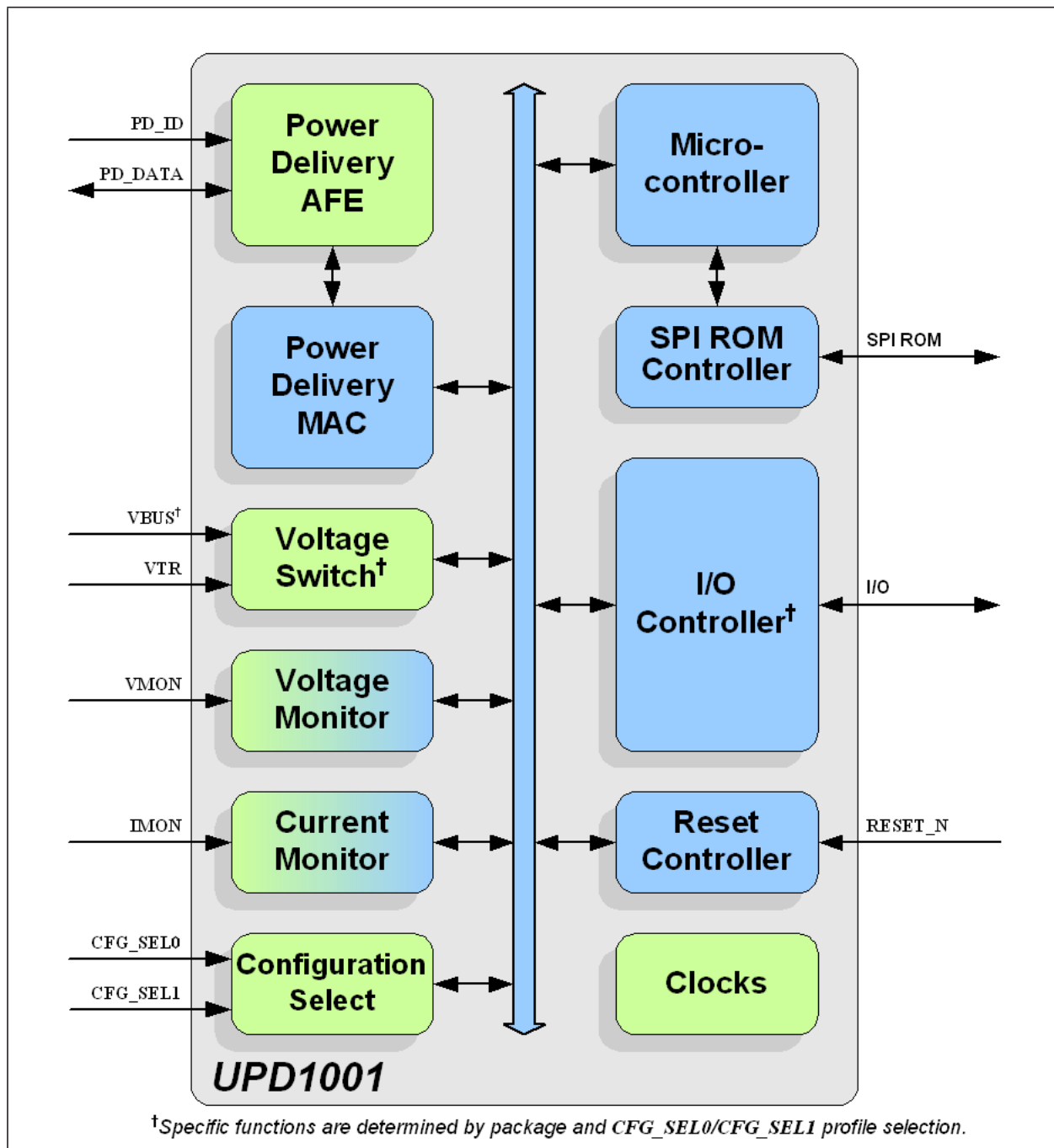


FIGURE 2-2: 28-TSSOP PACKAGE (DIMENSIONS)

COMMON DIMENSIONS					
SYMBOL	MIN	NOM	MAX	NOTE	REMARK
A	-	-	1.20	-	OVERALL PACKAGE HEIGHT
A1	0.00	-	0.15	7	STANDOFF
A2	0.80	1.00	1.05	-	BODY THICKNESS
D	9.60	9.70	9.80	3	X BODY SIZE
D1	4.80	4.90	5.00		X EXPOSED PAD
E	8.10 BSC			-	LEAD SPAN
E1	6.00	6.10	6.20	3	Y BODY SIZE
E2	4.00	4.10	4.20		Y EXPOSED PAD
L	0.45	0.60	0.75	-	LEAD FOOT LENGTH
L1	1.00 REF				LEAD LENGTH
b	0.19	-	0.30	2,4	LEAD WIDTH
c	0.09	-	0.20	4	LEAD FOOT THICKNESS
e	0.65 BSC			-	LEAD PITCH
S	0.20	-	-	-	LEAD SHOULDER
R	0.09	-	-	-	LEAD FOOT RADIUS
R1	0.09		-		LEAD SHOULDER RADIUS

REVISION HISTORY

REV	DESCRIPTION	DATE	RELEASED BY
A	INITIAL PRELIMINARY RELEASE	4/11/13	SKI

UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN MILLIMETERS
DECIMAL ANGULAR
X.XX .XX°
X.XXX .XXX°
INTERPRET DIM AND TOL PER
ASME Y14.5M - 20A

THIRD ANGLE PROJECTION

NAME

DATE

DRAWN

CHECKED

APPROVED

SKJ/JEV

SKJ/JEV

SKJ/JEV

TITLE

28 TSSOP, 6.1mm WIDE BODY, 0.65mm PITCH WITH EXPOSED PAD

DWG NUMBER

28TSSOP-6;1WIDE-0.65P-ePAD

SCALE

1:1

SHEET

2 OF 2

Note: For the most current package drawings, see the Microchip Packaging Specification at <http://www.microchip.com/package3>

PACKAGE OUTLINE

1. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

2. DIMENSION "b" DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 MM TOTAL IN EXCESS OF THE "b" DIMENSION AT MMC. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

3. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD IS 0.07 MM.

4. DIMENSION "d" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MAXIMUM MOLD FLASH, PROTRUSIONS OR GATE BURRS IS 0.15 MM PER SIDE. DIMENSION "E1" DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. MAXIMUM INTERLEAD FLASH OR PROTRUSION IS 0.25 MM PER SIDE. "D" & "E1" DIMENSIONS ARE DETERMINED AT DATUM PLANE "H".

5. "b" & "c" APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 TO 0.25 MM FROM THE LEAD TIP.

6. DETAILS OF THE PIN 1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.

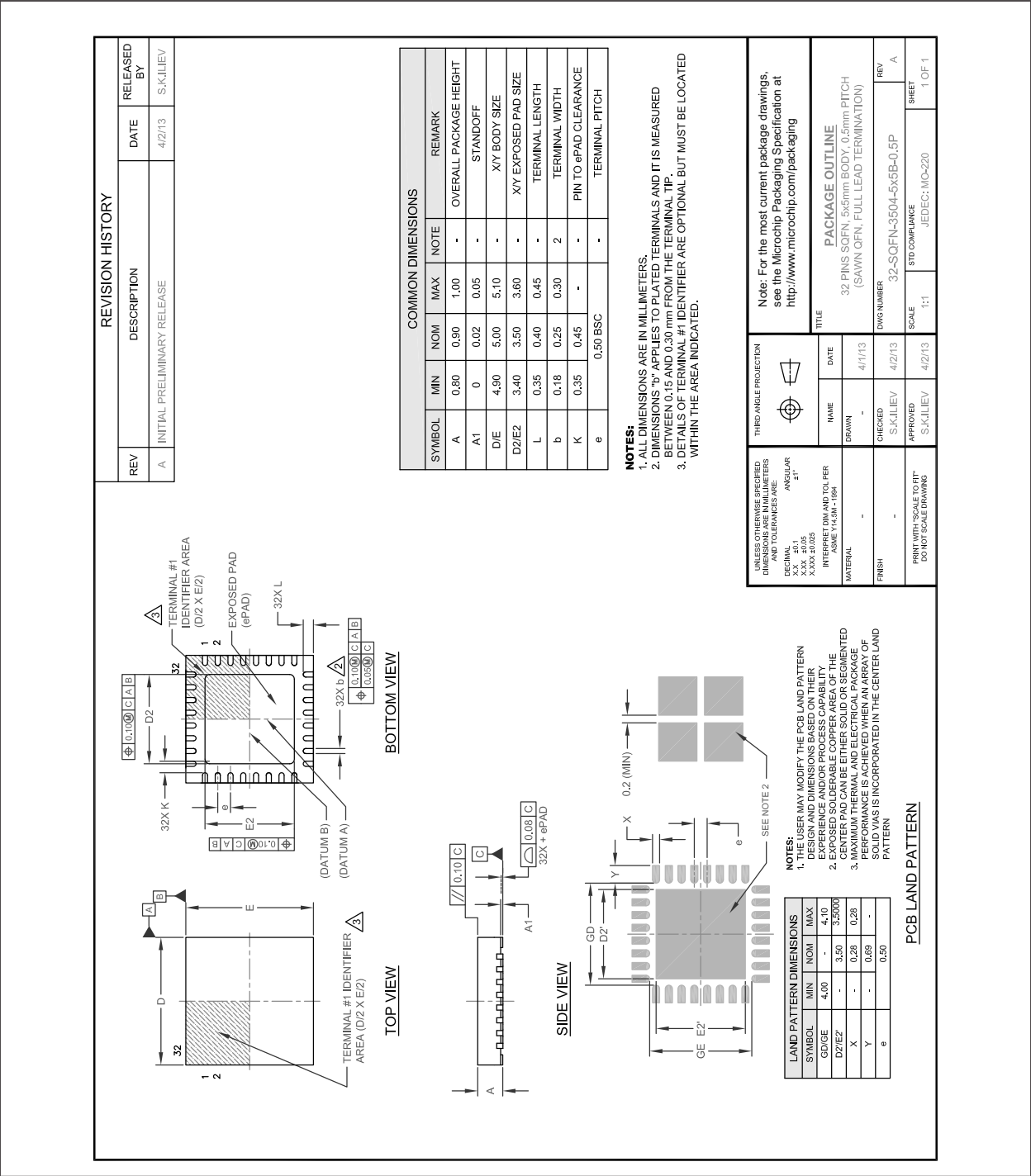
7. DATUMS "A" AND "B" TO BE DETERMINED AT DATUM PLANE "H".

8. "A1" IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY, EXCLUDING ANY THERMAL ENHANCEMENT ON CAVITY DOWN PACKAGE CONFIGURATIONS.

9. "D1" AND "E2" DIMENSIONS DO NOT INCLUDE MOLD FLASH

2.2 32-SQFN

FIGURE 2-3: 32-SQFN PACKAGE



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PART NO.		[X]	-	XX	/	XX
Device		Tape and Reel Option		Temperature Range		Package
Device:		UPD1001				
Tape and Reel Option:		Blank	= Standard packaging (tray)			
		T	= Tape and Reel (Note 1)			
Temperature Range:		A	= 0°C to +70°C (Commercial)			
		AI	= -40°C to +85°C (Industrial)			
		AV	= -40°C to +105°C (Automotive)			
Package:		ST	= 28-pin TSSOP			
		MQ	= 32-pin SQFN			

Examples:

a) UPD1001-A/ST
Tray, Commercial temp., 28-pin TSSOP

b) UPD1001T-AI/MQ
Tape & reel, Industrial temp., 32-pin SQFN

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

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